



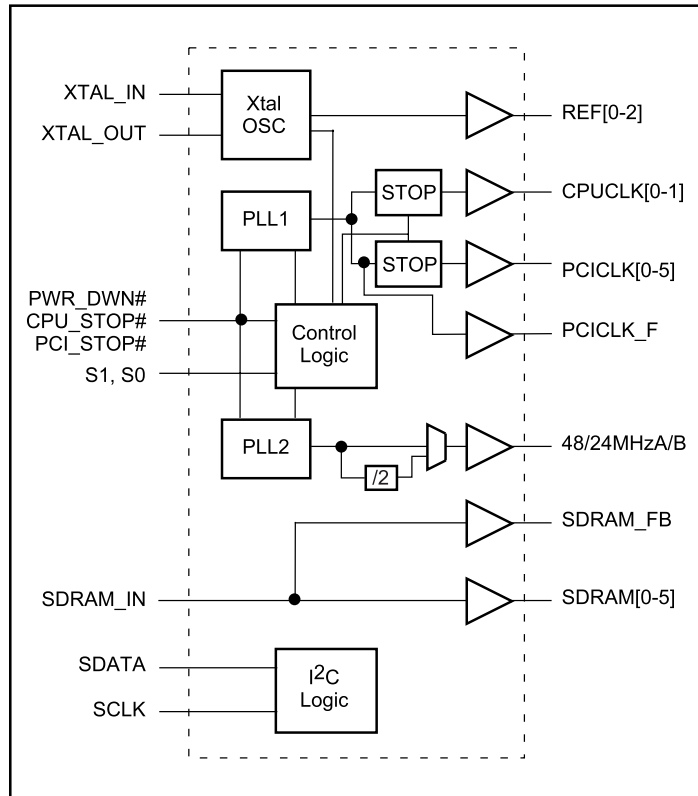
133 MHz Single Chip Mobile Clock
Supports 440 BX™/VIAPromedia™ Chipset
with Pentium II™/Pentium III™/Celeron™

Description

- Integrated clock and buffer for Pentium II[™]/Pentium III[™]/Celeron[™] processors
- I²C: 2-Wire Serial Interface. Device vendor ID is readable
- Edge rate control of clock output signals for EMI suppression
- Eight Spread Spectrum options for optimal EMI suppression
- Individual clock output enable/disable
- Two CPUCLKs, with enhanced drive
- Seven PCI clocks
- Seven SDRAM clocks for 3 SO DIMMs.
- Three 14.31818 MHz clocks
(REF2 has an enhanced output drive)
- Two 48/24 MHz clocks
- Low skew and low power consumption.
- Extended temperature range 0°C - 85°C
- Package: 48-pin 240 mil TSSOP(A)

PI6C673F is the ideal low-cost solution for the 66/100/133 MHz SDRAM-based mobile/handheld platform. It integrates high-speed, low-noise, low-jitter, and low-skew clock generator and SDRAM buffers. The device supports either discrete or modular processors, three SO DIMMs, two 48/24 MHz outputs for USB and Super I/O, and a combination of six PCI slots and devices. Power management controls are realized with standard control signals such as: PWR_DWN#, CPU_STOP#, and PCI_STOP#. To further reduce power consumption and to minimize EMI emission, each individual output can be enabled/disabled through I²C interface. A wide range of SSC (Spread Spectrum Clock) options allow users to choose the best mode for minimal EMI. Generous power supply pins ensure that the device will have low noise and high performance.

Pin Configuration



REF1	1	48	Vddq_3
REF0	2	47	N/C
Vss	3	46	Vddq_3
XTAL_IN	4	45	REF2
XTAL_OUT	5	44	PWR_DWN#
S1	6	43	Vss
Vddq_3	7	42	CPUCLK0
PCICLK_F	8	41	CPUCLK1
PCICLK0	9	40	Vddq_2
Vss	10	39	SDRAM_IN
PCICLK1	11	38	SDRAM_FB
PCICLK2	12	37	Vss
PCICLK3	13	36	SDRAM0
PCICLK4	14	35	SDRAM1
Vddq_3	15	34	Vddq_3
PCICLK5	16	33	SDRAM2
Vss	17	32	SDRAM3
S0	18	31	Vss
SDATA	19	30	SDRAM4
SCLK	20	29	SDRAM5
Vddq_3	21	28	Vddq_3
48/24MHzA	22	27	CPU_STOP#
48/24MHzB	23	26	PCI_STOP#
Vss	24	25	Vddq_3



Frequency Selection Table

S1	S0	CPUCLK	PCICLK
0	0	60.0	30.0
0	1	66.6	33.3
1	0	133.3	33.3
1	1	100	33.3

Pin Description

Pin	Type	Qty	Signal Name	Description
2,1,45	Out	3	REF[0-2]	14.318 MHz clock outputs.
8	Out	1	PCICLK_F	Free running PCI clock, not affected by PCI_STOP#.
9,11,12,13,14,16	Out	6	PCICLK[0-5]	PCI Clocks
6,18	In	1	S1,S0	See Frequency Selection Table & Frequency Selection Pin
22,23	Out	2	48/24MHzA, 48/24MHzB	48/24 MHz clock, selectable by I ² C. Default to 48 MHz.
29,30,32,33,35,36	Out	6	SDRAM[0-5]	SDRAM clocks, same frequency as SDRAM_IN.
27	In	1	CPU_STOP#	Stop CPUCLKs, active LOW.
26	In	1	PCI_STOP#	Stop PCICLKs, except PCICLK_F. Active LOW.
41,42	Out	2	CPUCLK	Host clock outputs, powered by Vddq_2.
38	Out	1	SDRAM_FB	Feedback clock output, same frequency as SDRAM_IN.
39	In	1	SDRAM_IN	Clock input for SDRAM[0-5] and SDRAM_FB outputs.
44	In	1	PWR_DWN#	Powers down the chip, active LOW.
4	In	1	XTAL_IN	Crystal input or driven by an externally generated reference clock input.
5	Out	1	XTAL_OUT	Crystal output. If an externally generated reference clock input is used at XTAL_IN pin, this pin is unconnected.
19	Bi-Dir	1	SDATA	Serial data in for serial configuration port. Has internal pull-up resistor. Conforms to the Philips I ² C spec.
20	In	1	SCLK	Clock input for serial configuration port. Has internal pull-up resistor. Conforms to the Philips I ² C spec.
7,15,21,25,28,34,46,48	Power	8	Vddq_3	3.3V I/O power supply.
40	Power	1	Vddq_2	2.5V CPU Clock power supply.
3,10,17,24,31,37,43	Ground	7	VSS	Ground, common.

Power Management: Clock Enable Configuration*

CPU_STOP#	PCI_STOP#	PWR_DWN#	CPUCLK	PCICLK	Other Clock: SDRAM, REF, 48/24 MHz A 48/24 MHz B	Crystal, VCOs
X	X	0	low	low	low	off
0	0	1	low	low	running	running
0	1	1	low	running	running	running
1	0	1	running	low	running	running
1	1	1	running	running	running	running

*Full clock cycle timing is guaranteed at all times after initially powered up.

PI6C673 Power Management Requirements

Signal	Signal state	Latency: No. of rising edges of free-running PCICLK
CPU_STOP#	1 (enabled) ⁽¹⁾	1
	0 (disabled) ⁽²⁾	1
PCI_STOP#	1 (enabled) ⁽¹⁾	1
	0 (disabled) ⁽²⁾	1
PWR_DWN#	1 (normal operation) ⁽³⁾	2
	0 (power down)	2

Notes:

1. Clock ON latency is defined from when the clock enable goes active to the first valid clock.
2. Clock OFF latency is defined from when the clock enable goes inactive to the last clock is driven low out of the device.
3. Power UP latency is when PWR_DWN# goes inactive (HIGH) to when the first valid clocks are driven from the device.

I²C Serial Interface

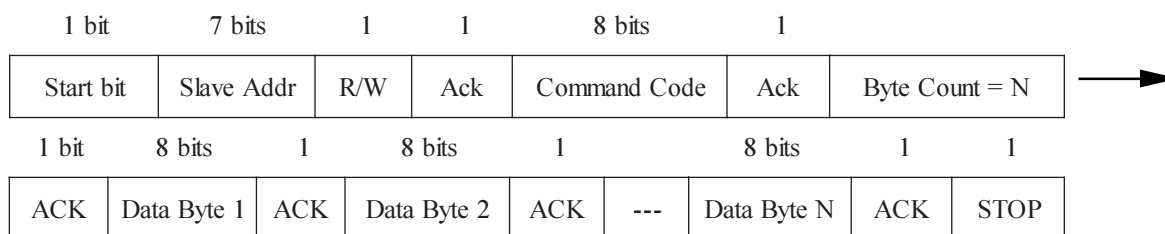
By using standard I²C command bytes, the I²C registers can be written.

The ID number at Byte 8 can be read back for identification purposes.

Address Assignment

A6	A5	A4	A3	A2	A1	A0	R/W
1	1	0	1	0	0	1	-----

Data Protocol





Byte 0: Functional and Frequency Select Clock Register (1 = enable, 0 = disable)

Bit	Pin #	Power-Up Default	Description
Bit 7	N/A	X	(Reserved)
Bit 6	N/A	1	Spread Spectrum Selection bit SSC2
Bit 5	N/A	1	Spread Spectrum Selection bit SSC1
Bit 4	N/A	1	Spread Spectrum Selection bit SSC0
Bit 3	22	1	48/24 MHz A (Freq Select) 1=48MHz, 0=24 MHz
Bit 2	23	1	48/24 MHz B (Freq Select) 1=48MHz, 0=24 MHz
Bit 1 Bit 0	N/A N/A	0 0	Bit1 Bit 0 1 1 : Tri-State (all outputs) 1 0 : Spread Spectrum enabled 0 1 : Test mode (see table) 0 0 : Non-Spread Spectrum Operating Mode

Spread Spectrum Bandwidth Selection Table

SSC2	SSC1	SSC0	Bandwidth	Direction
0	0	0	±0.625%	Center
0	0	1	±0.5%	Center
0	1	0	-0.35%	Down
0	1	1	-0.25%	Down
1	0	0	-2.5%	Down
1	0	1	-1%	Down
1	1	0	-1.21%	Down
1	1	1	-0.9%	Down (default)

Test Mode Selection

S1	S0	CPU	PCI, PCI_F	REF	24 MHz	48 MHz
0	0	TCLK/4	TCLK/8	TCLK	TCLK/4	TCLK/2
0	1	TCLK/4	TCLK/8	TCLK	TCLK/4	TCLK/2
1	0	TCLK/4	TCLK/12	TCLK	TCLK/4	TCLK/2
1	1	TCLK/4	TCLK/12	TCLK	TCLK/4	TCLK/2

Note:

TCLK is a test clock over driven on the XTAL_IN input during test mode.

Byte 1: CPU, 24/48 MHz Active/Inactive Register

(1 = enabled, 0 = stopped, output held LOW)

Bit	Pin #	Power-Up Default	Description
Bit 7	22	1	48/24 MHz A (Enabled/Stopped)
Bit 6	23	1	48/24 MHz B (Enabled/Stopped)
Bit 5	N/A	X	(Reserved)
Bit 4	N/A	1	(Reserved)
Bit 3	38	1	SDRAM_FB (Enabled/Stopped)
Bit 2	—	1	(Reserved)
Bit 1	41	1	CPUCLK1 (Enabled/Stopped)
Bit 0	42	1	CPUCLK0 (Enabled/Stopped)

Byte 2: PCI Active/Inactive Register

(1 = enable, 0 = stopped, output held LOW)

Bit	Pin #	Power-Up Default	Description
Bit 7	N/A	x	Reserved
Bit 6	8	1	PCICLK_F (Enabled/Stopped)
Bit 5	16	1	PCICLK5 (Enabled/Stopped)
Bit 4	14	1	PCICLK4 (Enabled/Stopped)
Bit 3	13	1	PCICLK3 (Enabled/Stopped)
Bit 2	12	1	PCICLK2 (Enabled/Stopped)
Bit 1	11	1	PCICLK1 (Enabled/Stopped)
Bit 0	9	1	PCICLK0 (Enabled/Stopped)

Byte 3: SDRAM Active/Inactive Register

(1 = enabled, 0 = stopped, output held low)

Bit	Pin #	Power-Up Default	Description
Bit 7	N/A	1	(Reserved)
Bit 6	N/A	1	(Reserved)
Bit 5	29	1	SDRAM5 (Enabled/Stopped)
Bit 4	30	1	SDRAM4 (Enabled/Stopped)
Bit 3	32	1	SDRAM3 (Enabled/Stopped)
Bit 2	33	1	SDRAM2 (Enabled/Stopped)
Bit 1	35	1	SDRAM1 (Enabled/Stopped)
Bit 0	36	1	SDRAM0 (Enabled/Stopped)



Byte 4: Reserved

Bit	Pin #	Power-Up Default	Description
Bit 7	N/A	1	Reserved
Bit 6	N/A	1	Reserved
Bit 5	N/A	1	Reserved
Bit 4	N/A	1	Reserved
Bit 3	N/A	1	Reserved
Bit 2	N/A	1	Reserved
Bit 1	N/A	1	Reserved
Bit 0	N/A	1	Reserved

Byte 5: Peripheral Active/Inactive Register (1= enabled, 0 = stopped)

Bit	Pin #	Power-Up Default	Description
Bit 7	N/A	X	Reserved
Bit 6	N/A	1	Reserved
Bit 5	N/A	1	Reserved
Bit 4	45	1	REF2 (Enabled/Stopped)
Bit 3	N/A	X	Reserved
Bit 2	N/A	1	Reserved
Bit 1	1	1	REF1 (Enabled/Stopped)
Bit 0	2	1	REF0 (Enabled/Stopped)

Byte 8: Pericom ID Register (Read only, not writable)

Bit	Pin #	Power-Up Default	Description
Bit 7		0	x50H, ASCII Character Upper Case "P"
Bit 6		1	
Bit 5		0	
Bit 4		1	
Bit 3		0	
Bit 2		0	
Bit 1		0	
Bit 0		0	

Maximum Ratings

Description	Min.	Max.
Input Voltage	V _{SS} - 0.5V	V _{DD} + 0.5V
Storage temperature	-65°C	150°C

Recommended Operating Conditions

Parameter	Operating Conditions
V _{DDQ_3}	3.3V ±5%
V _{DDQ_2}	2.5V ±5%
Ambient temperature	0°C to +85°C

DC Characteristics at Recommended Operating Conditions⁽²⁾

Parameter	Min.	Typ.	Max.	Units
Input Low voltage for S[0:1], CPU_STP#, PCI_STP#, PWR_DWN#			0.8	V
Input High voltage for S[0:1], CPU_STP#, PCI_STP#, PWR_DWN#	2.0			
Tri-State leakage current			10	μA
Dynamic supply current, I _{DD} , at CPUCLK = 100 MHz			150	mA
Static supply current (PWR_DWN# = 0)			200	μA

AC Characteristics at Recommended Operating Conditions^(1,2)

Parameter	Min.	Typ.	Max.	Units
CPUCLK leading PCICLK offset	1		4	ns
Clock output duty cycle	45	50	55	%
Skews: (CPUCLK-CPUCLK), (PCICLK-PICCLK), (SDRAM-SDRAM)			175	ps
Period Jitter, adjacent cycles (CPUCLK, SDRAM)			250	
Period Jitter, adjacent cycles (PCICLK, 48/24 MHz)			500	

Notes:

1. CPUCLKs are measured at 1.25V, other clock outputs are measured at 1.5V.
2. Loads: CPUCLKs, 48/24 MHz, and REF clocks: 20pF max., SDRAMs, PCICLKs: 30pF max.

CPUCLK(0:1) 2.5V Buffer Characteristics ($T_A=0\sim70^\circ\text{C}$; $V_{ddq_2}=2.5\text{V}\pm5\%$; $C_L=20\text{pF}$)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
Ioh	Pull-up current	$V_{out} = V_{ddq_2} - 0.5\text{V}$	-23	-34		mA
Ioh	Pull-up current	$V_{out} = 1.2\text{V}$	-37	-72		
Iol	Pull-down current	$V_{out} = 0.4\text{V}$	15	28		
Iol	Pull-down current	$V_{out} = 1.2\text{V}$	38	75		
tr	Rise time	0.4V-2.0V	0.4		1.3	ns
tf	Fall time	2.0V-0.4V	0.4		1.3	

PCICLK(_F,0:5) 3.3V Buffer Characteristics ($T_A=0\sim70^\circ\text{C}$; $V_{ddq_3}=3.3\text{V}\pm5\%$; $C_L=30\text{pF}$)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
Ioh	Pull-up current	$V_{out} = V_{ddq_3} - 0.5\text{V}$	-23	-16		mA
Ioh	Pull-up current	$V_{out} = 1.5\text{V}$	-48	-46		
Iol	Pull-down current	$V_{out} = 0.4\text{V}$	13	14		
Iol	Pull-down current	$V_{out} = 1.5\text{V}$	44	47		
tr	Rise time	0.4V-2.4V	0.4		2.4	ns
tf	Fall time	2.4V-0.4V	0.4		2	

48/24 MHz (A,B), 3.3V Buffer Characteristics ($T_A=0\sim70^\circ\text{C}$; $V_{ddq_3}=3.3\text{V}\pm5\%$; $C_L=20\text{pF max.}$)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
Ioh	Pull-up current	$V_{out} = V_{ddq_3} - 0.5\text{V}$	-23	-13		mA
Ioh	Pull-up current	$V_{out} = 1.5\text{V}$	-48	-32		
Iol	Pull-down current	$V_{out} = 0.4\text{V}$	13	12		
Iol	Pull-down current	$V_{out} = 1.5\text{V}$	40	34		
tr	Rise time	0.4V-2.4V	0.4		4	ns
tf	Fall time	2.4V-0.4V	0.4		4	

SDRAM(_FB,0:5), Buffer Characteristics ($T_A=0\sim70^{\circ}\text{C}$; $V_{ddq_3}=3.3\text{V}\pm5\%$; $C_L=30\text{pF}$)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{oh}	Pull-up current	$V_{out} = V_{ddq_3} - 0.5\text{V}$	-27	-21		mA
		$V_{out} = 1.5\text{V}$	-56	-66		
I_{ol}	Pull-down current	$V_{out} = 0.4\text{V}$	22	19		
		$V_{out} = 1.5\text{V}$	74	65		
t_r	Rise time	0.4V-2.4V	0.4		1.8	ns
t_f	Fall time	2.4V-0.4V	0.4		1.8	

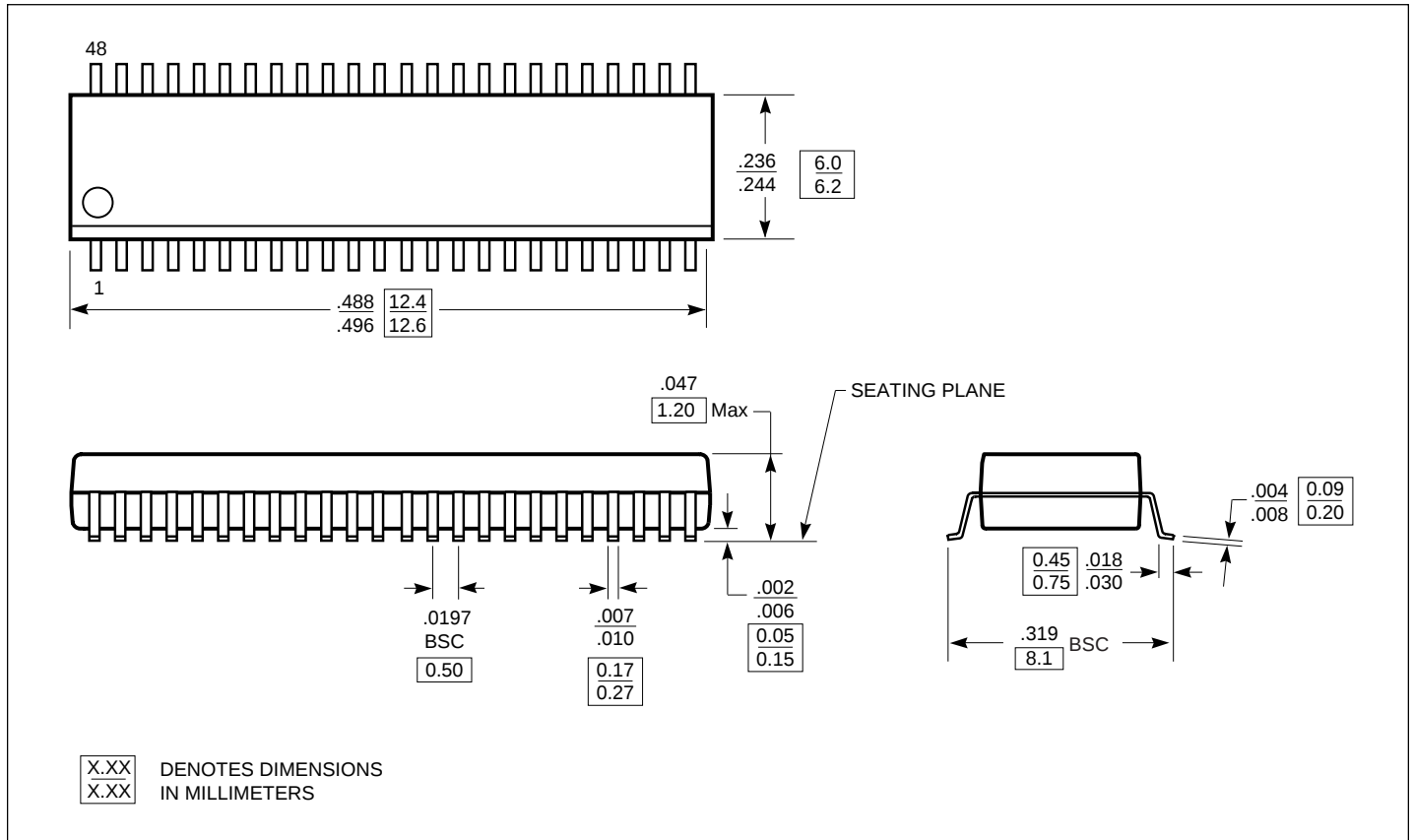
REF2 Buffer Characteristics ($T_A=0\sim70^{\circ}\text{C}$; $V_{ddq_3}=3.3\text{V}\pm5\%$; $C_L=20\text{pF}$)

Symbol	Characteristic	Conditions	Min.	Typ.	Max.	Units
I_{oh}	Pull-Up Current	$V_{out} = V_{ddq_3} - 0.5\text{V}$	-23	-29		mA
		$V_{out} = 1.5\text{V}$	-48	-72		
I_{ol}	Pull-Down Current	$V_{out} = 0.4\text{V}$	13	26		
		$V_{out} = 1.5\text{V}$	44	71		
T_r/T_f	Rise/Fall Time	0.4V - 2.4V	0.4		1.5	ns

REF(0:1) Buffer Characteristics ($T_A=0\sim70^{\circ}\text{C}$; $V_{ddq_3}=3.3\text{V}\pm5\%$; $C_L=20\text{pF}$)

Symbol	Characteristic	Conditions	Min.	Typ.	Max.	Units
I_{oh}	Pull-Up Current	$V_{out} = V_{ddq_3} - 0.5\text{V}$	-23	-16		mA
		$V_{out} = 1.5\text{V}$	-48	-41		
I_{ol}	Pull-Down Current	$V_{out} = 0.4\text{V}$	13	17		
		$V_{out} = 1.5\text{V}$	44	46		
T_r/T_f	Rise/Fall Time	0.4V - 2.4V	0.4		1.5	ns

48-pin TSSOP (A)



Ordering Information

Part Number	Description
PI6C673FA	133 MHz, 48-pin TSSOP